FAIRCHILD

SEMICONDUCTOR TM

November 1998

FDG6321C Dual N & P Channel Digital FET

General Description

These dual N & P-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETS. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.

Features

- N-Ch 0.50 A, 25 V, $R_{\rm DS(ON)} = 0.45 \ \Omega \ @ V_{\rm GS} = 4.5 V.$ $R_{\rm DS(ON)} = 0.60 \ \Omega \ @ V_{\rm GS} = 2.7 \ V.$
- P-Ch -0.41 A, -25 V, $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5V.$ $R_{DS(ON)} = 1.5 \Omega @ V_{GS} = -2.7V.$
- Very small package outline SC70-6.
- Very low level gate drive requirements allowing direct operation in 3 V circuits(V_{GS(th)} < 1.5 V).
- Gate-Source Zener for ESD ruggedness (>6kV Human Body Model).

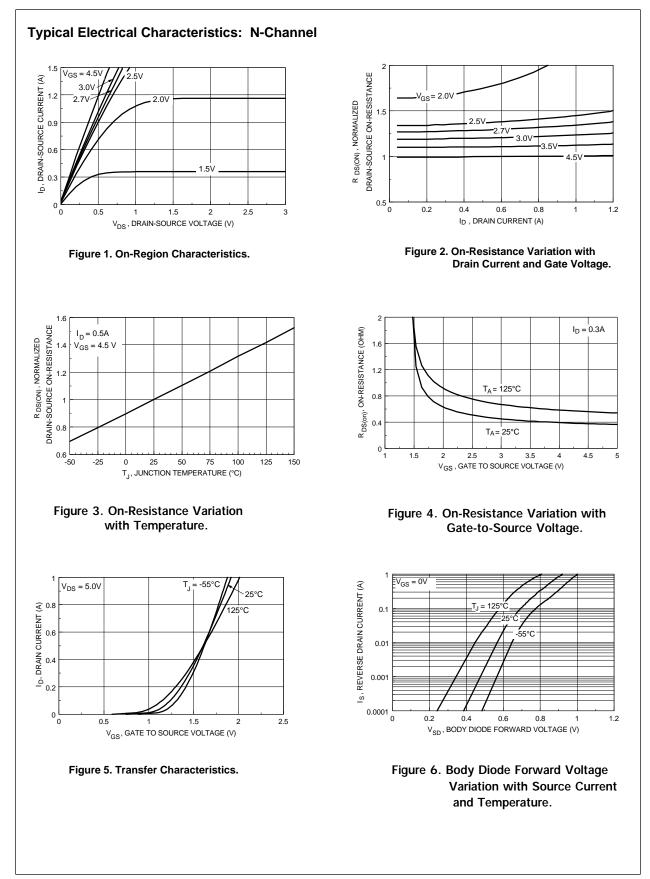
SC70	•	SOT-23	SuperSOT [™] -6	SOT-8	SO-8	
						SOIC-14
	D1 SC70	G2 S1 G2 C2 C1 C1 C2 C1 C2 C1 C2 C2 C1 C2 C2 C2 C2 C2 C2 C2 C2 C2 C2 C2 C2 C2	2			
Absol	ute Maxim	num Ratings ⊺	$\bar{a}_{A} = 25^{\circ}$ C unless otherwise r	noted		
	ute Maxim Paramete		$_{A} = 25^{\circ}$ C unless otherwise r	noted N-Channel	P-Channel	Units
ymbol		r	⁷ _A = 25°C unless otherwise r		P-Channel -25	Units V
ymbol _{DSS}	Paramete	r ce Voltage	_A = 25°C unless otherwise r	N-Channel		
ymbol _{DS} s GSS	Parameter Drain-Sour	r ce Voltage ce Voltage	⁻ _A = 25°C unless otherwise r	N-Channel 25	-25	V
ymbol _{DS} s GSS	Parameter Drain-Sour Gate-Sour	r ce Voltage ce Voltage	⁻ _A = 25°C unless otherwise r	N-Channel 25 8	-25	V V
ymbol _{DSS} GSS	Parameter Drain-Sour Gate-Sourd Drain Curr	r ce Voltage ce Voltage rent - Continuous	A = 25°C unless otherwise r	N-Channel 25 8 0.5	-25 -8 -0.41	V V
ymbol _{DSS} gss D	Parameter Drain-Sour Gate-Sour Drain Curr Maximum	r rce Voltage ce Voltage rent - Continuous - Pulsed	(Note 1)	N-Channel 25 8 0.5 1.5	-25 -8 -0.41 -1.2	V V A
Symbol (DSS (GSS)))))))))))))	Parameter Drain-Sour Gate-Sour Drain Curr Maximum Operating Electrostat	r ce Voltage ce Voltage rent - Continuous - Pulsed Power Dissipation	(Note 1) rature Ranger 1 MIL-STD-883D	N-Channel 25 8 0.5 1.5	-25 -8 -0.41 -1.2 0.3	V V A W
Symbol (DSS (GSS) (GSS) (DD) (DD) (DD) (DS) (CD) (DD) (DD) (DD) (DD) (DD) (DD) (DD	Parameter Drain-Sour Gate-Sour Drain Curr Maximum Operating Electrostat	r ce Voltage rent - Continuous - Pulsed Power Dissipation and Storage Temper ic Discharge Rating dy Model (100pf / 1	(Note 1) rature Ranger 1 MIL-STD-883D	N-Channel 25 8 0.5 1.5	-25 -8 -0.41 -1.2 0.3 5 to 150	V V A W ©C

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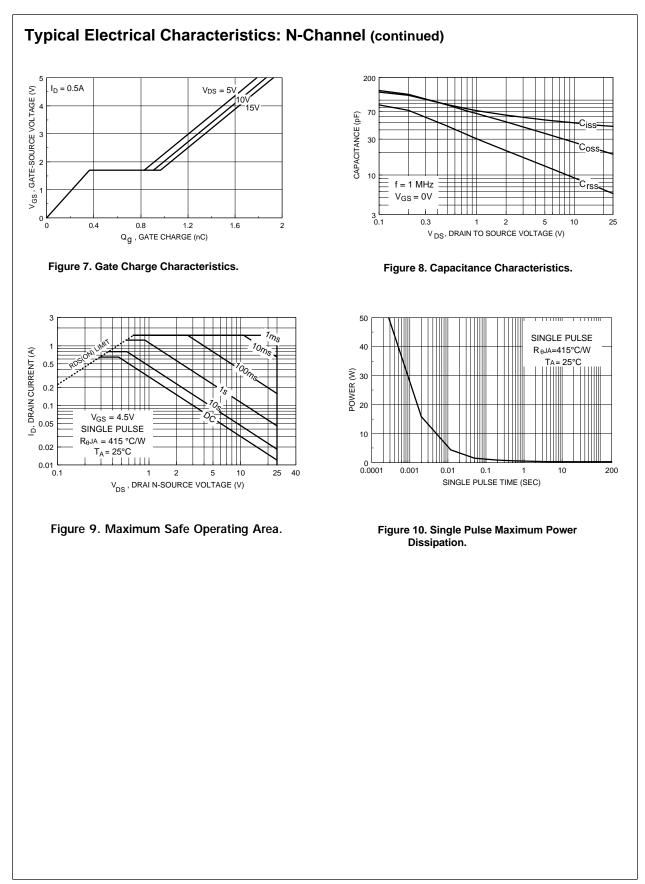
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS		51				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	N-Ch	25			V
033		$V_{gs} = 0 \text{ V}, \text{ I}_{p} = -250 \mu\text{A}$	P-Ch	-25			
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_p = 250 \mu\text{A}$, Referenced to $25 ^{\circ}\text{C}$	N-Ch		26		mV/ºC
DSS' DSS' DSS' DSS' DSS' DSS' DSS' DSS'		$I_{\rm D}$ = -250 µA, Referenced to 25 °C	P-Ch		-22		+
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch			1	μA
000		T ₁ = 55°C	_			10	·
I _{GSS}	Gate - Body Leakage Current	$V_{\rm DS} = -20 \text{ V}, V_{\rm GS} = 0 \text{ V}$	P-Ch			-1	μA
		T ₁ = 55°C				-10	
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	N-Ch			100	nA
000		$V_{gs} = -8 \text{ V}, V_{Ds} = 0 \text{ V}$	P-Ch			-100	nA
ON CHARA	CTERISTICS (Note 2)					1	1
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	0.65	0.8	1.5	V
(-)		$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu {\rm A}$	P-Ch	-0.65	-0.82	-1.5	
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C	N-Ch		-2.6		mV/ °C
00(11) 3		I_{D} = -250 µA, Referenced to 25 °C	P-Ch		2.1		Ì
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \ I_{D} = 0.5 \text{ A}$	N-Ch		0.34	0.45	Ω
		T _J =125°C			0.55	0.72	Ī
		$V_{GS} = 2.7 \text{ V}, \ I_{D} = 0.2 \text{ A}$			0.44	0.6	Ī
		$V_{GS} = -4.5 \text{ V}, \ I_{D} = -0.41 \text{ A}$	P-Ch		0.85	1.1	
		T _J =125°C			1.2	1.8	
		$V_{GS} = -2.7 \text{ V}, \ I_{D} = -0.25 \text{ A}$			1.15	1.5	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, \ V_{DS} = 5 \text{ V}$	N-Ch	0.5			А
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	P-Ch	-0.41			
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \ \text{I}_{D} = \ 0.5 \text{ A}$	N-Ch		1.45		S
		$V_{DS} = -5 V, I_{D} = -0.41 A$	P-Ch		0.9		
DYNAMIC C	HARACTERISTICS	1				1	1
C _{iss}	Input Capacitance	N-Channel	N-Ch		50		pF
		$V_{DS} = 10 V, V_{GS} = 0 V,$	P-Ch		62		
C _{oss}	Output Capacitance	f = 1.0 MHz	N-Ch		28		
		P-Channel	P-Ch		34		-
C _{rss}	Reverse Transfer Capacitance	$V_{\rm DS} = -10 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$	N-Ch		9		
		f = 1.0 MHz	P-Ch		10		

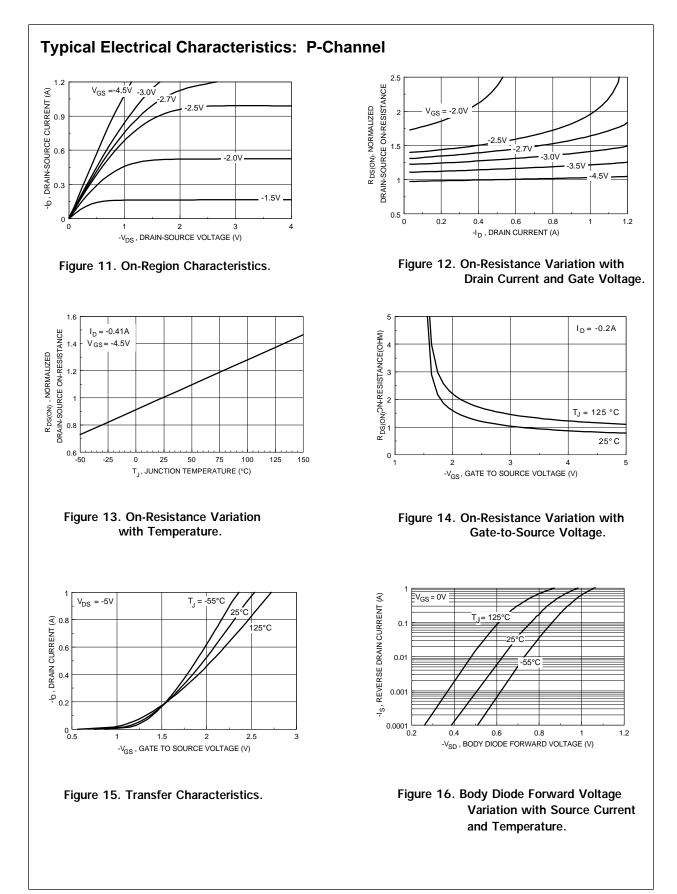
SWITCHING CHARACTERISTICS (Note 2)							
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
t _{D(on)}	Turn - On Delay Time	N-Channel	N-Ch		3	6	nS
		$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A},$	P-Ch		7	15	
ţ	Turn - On Rise Time	$V_{\rm GS}$ = 4.5 V, $R_{\rm GEN}$ = 50 Ω	N-Ch		8.5	18	nS
			P-Ch		8	16	
t _{D(off)}	Turn - Off Delay Time	P-Channel	N-Ch		17	30	nS
		$V_{DD} = -5 V, I_{D} = -0.5 A,$	P-Ch		55	80	
t _r	Turn - Off Fall Time	V_{GS} = -4.5 V, R_{GEN} = 50 Ω	N-Ch		13	25	nS
			P-Ch		35	60	
Q _g	Total Gate Charge	N-Channel	N-Ch		1.64	2.3	nC
		$V_{\rm DS} = 5 \text{ V}, \text{ I}_{\rm D} = 0.5 \text{ A},$	P-Ch		1.1	1.5	
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$	N-Ch		0.38		nC
		P- Channel	P-Ch		0.31		
Q _{gd}	Gate-Drain Charge	$V_{\rm DS}$ = -5 V, I _D = -0.41 A,	N-Ch		0.45		nC
		$V_{GS} = -4.5 V$	P-Ch		0.29		
DRAIN-SC	OURCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS					
I _s	Maximum Continuous Drain-Source Diode Forward Current		N-Ch			0.25	А
						-0.25	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \ I_{S} = 0.5 \text{ A} \ (\text{Note 2})$	N-Ch		0.8	1.2	V
		$V_{GS} = 0 V, I_{S} = -0.5 A$ (Note 2)	P-Ch		-0.85	-1.2	

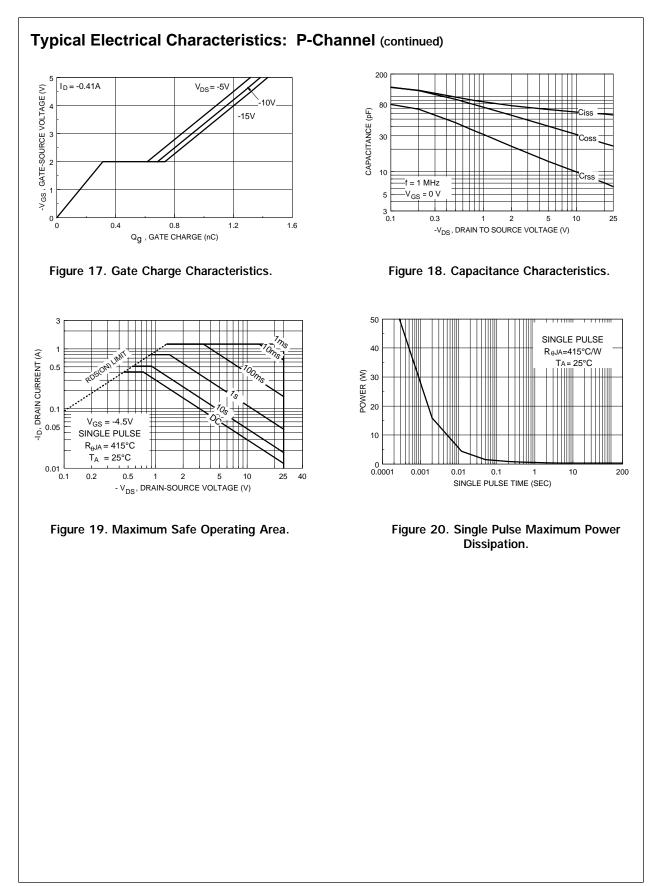
design while R_{act} is determined by the user's board design. R_{BJA} = 415^oC/W on minimum mounting pad on FR-4 board in still air.
Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%.

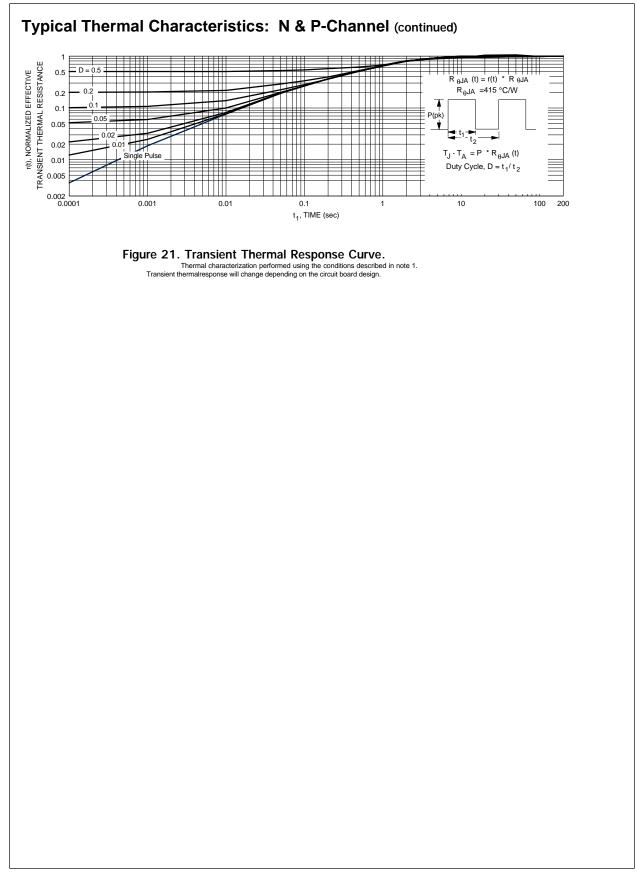


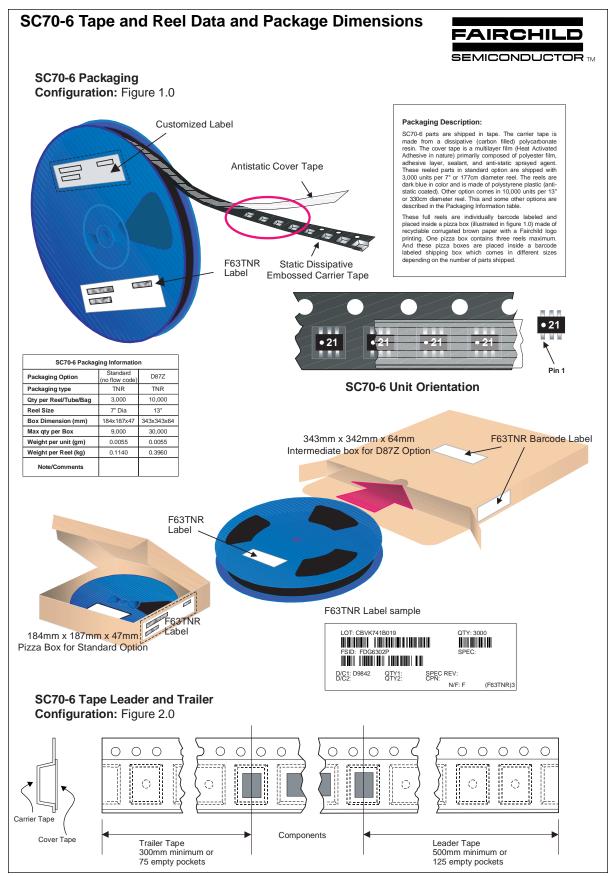
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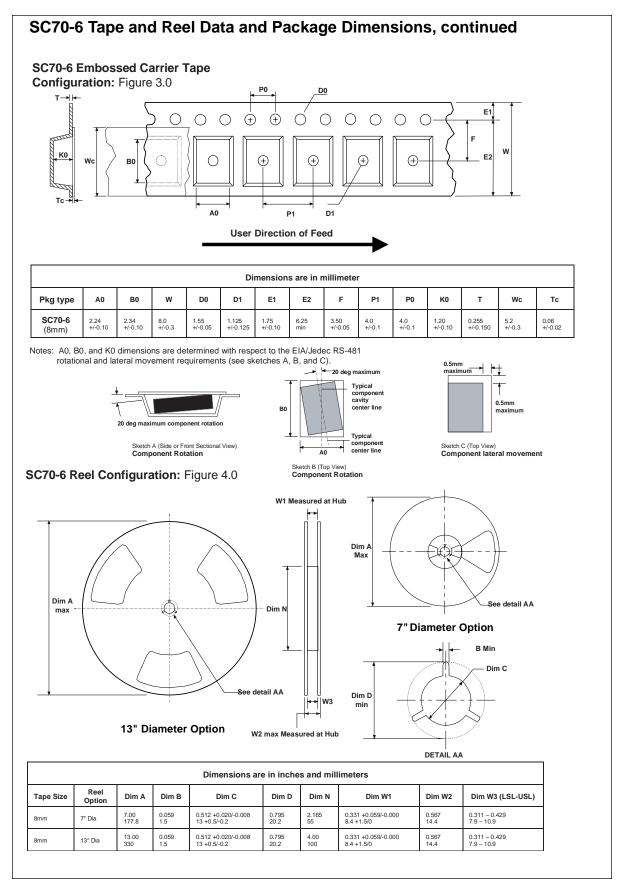




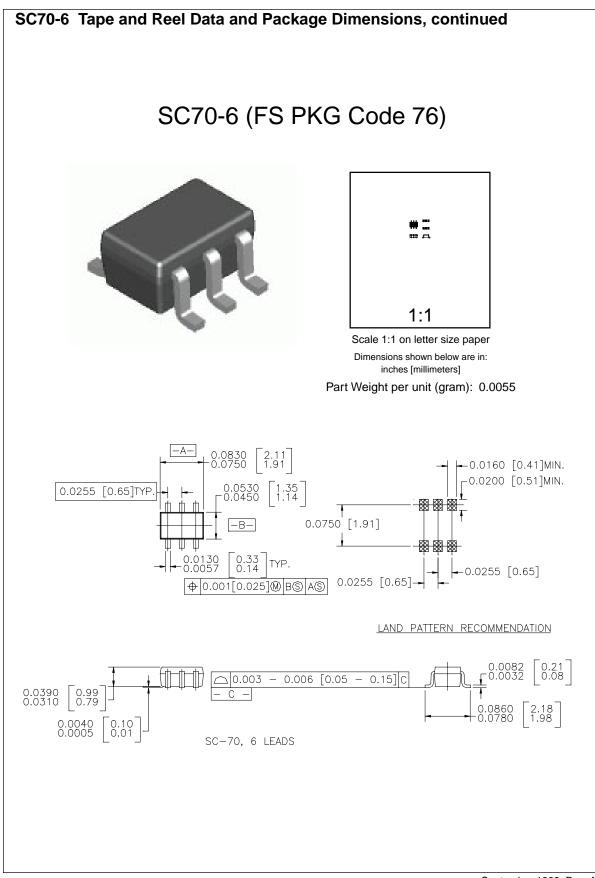




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